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Temperature-stable operation of a quantum dot semiconductor disk laser

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We demonstrate temperature-independent output characteristics of an optically pumped semiconductor disk laser (SDL) based on quantum dots (QDs) grown in the Stranski-Krastanow regime. The gain structure consists of a stack of 7×3 QD layers, each threefold group being located at an optical antinode position. The SDL emits at 1210 nm independent of the pump power density. Threshold and differential efficiency do not dependent on heat sink temperature. Continuous-wave operation close to 300 mW output power is achieved using the ground-state transition of the InGaAs QDs. © 2008 American Institute of Physics. [DOI: 10.1063/1.2968137]

Optically pumped semiconductor disk lasers, also referred to as vertical-external-cavity surface-emitting lasers (VECSELs), are very promising as high-power continuouswave (cw) and short pulse light sources.^{1–5} Excellent, almost diffraction-limited beam quality with good power scalability^{1,6} was demonstrated for a wide spectral range accessible by efficient intra-cavity frequency upconversion.^{2,7,8} Future applications such as low-cost laser-based full-color video projection thus become feasible using well-established GaAs-based technology. Red color rendering for such systems requires infrared emission beyond 1200 nm. In this wavelength range InGaAs quantum well (OW) structures face difficulties due to the large built-in strain. VECSELs for this wavelength range based on GaAsSb or GaInNAs QWs have been reported.^{1–3,6–10} However, strong temperature dependence of the emission wavelength is inherent to all QWbased VECSELs due to the spectrally comparatively small and temperature-dependent gain spectrum of QWs. Careful spectral detuning of the QW emission wavelength with respect to the cavity resonance at room temperature is required to obtain maximum output power at device operation temperatures ranging from 60 to 120 °C. Since the device temperature is influenced both by the incident pump power density as well as by heat dissipation via the heat sink and the heat spreader, device characteristics such as emission wavelength, threshold, and differential efficiency of QW-based VECSELs generally change depending on operation conditions.¹⁰ In contrast to QWs, quantum dots (QDs) prove a much broader gain spectrum as well as high thermal stability.¹¹ QD-based lasers have demonstrated excellent performance in the spectral range from 980 to 1500 nm.^{12,13} Recently, first QD-based VECSELs have been presented with cw operation at 1040 nm wavelength.^{5,14} The broad and flat gain spectrum of QDs offers the advantage of a temperatureindependent matching of the gain maximum with a given cavity resonance. Such characteristics are expected to result in temperature-independent device operation. In this letter, we present a VECSEL using the ground-state transitions of InGaAs QDs grown in the Stranski-Krastanow growth

mode. Indeed, output characteristics being independent of temperature in terms of threshold, differential efficiency, and the emission spectrum is demonstrated. First devices achieved 300 mW cw output power at 1210 nm with a low threshold.

The active mirror of the VECSEL is composed of a semiconductor distributed Bragg reflector (DBR), the gain region consists of the QD layers, and a confinement window which prevents diffusion of the photoexcited charge carriers toward the surface. The structure was designed using the transfer-matrix method with material parameters taken from 15. The DBR consists of 37.5 pairs Ref. of $Al_{0.98}Ga_{0.02}As/Al_{0.2}Ga_{0.8}As \lambda/4$ layers resulting in a spectral stop-band width of 80 nm and a nominal reflectivity of 99.96%. Pump-light absorption by the gain-medium section takes place in the GaAs layers which enclose 21 QD layers. The thickness of the semiconductor gain medium is about 2.3 μ m. From the characteristics of QD edge emitters based on similar dots a transparency current density of about 10 A/cm² per QD layer is calculated.¹⁶ Thus transparency of the whole stack is reached at incident power density levels well below 1 kW/cm². Defect-free QDs are essential since defect multiplication at successive QD layers may easily occur upon stacking with such large layer numbers, leading to rapidly degrading device performance. Furthermore, for QD layer spacings below ~ 40 nm strain-induced structural coupling between individual QD layers leads to increased inhomogeneous broadening upon stacking due to increased QD sizes.¹⁷ Requirements for uniform defect-free dots are met for a minimum spacer thickness of 45 nm as proven by photoluminescence (PL) spectroscopy and inspection of the surface morphology. Such spacer thickness allows for three symmetrically positioned QD layers per antinode. Given a modal gain value of $\sim 5 \text{ cm}^{-1}$ per QD layer for the groundstate transition^{18,19} for similar layers modeling shows that lasing can be achieved with 21 QD layers using a highly reflecting (R > 99.8 %) output coupling mirror. The topmost carrier-diffusion barrier is realized by a lattice-matched 65 nm thick In_{0.48}Ga_{0.53}P layer which is transparent to the pump light and does not require an absorbing GaAs oxidation-protection layer.

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FIG. 1. (Color online) Left and top axes: light output characteristics with heat sink set to different temperatures. Right and bottom axes: PL of sixfold QD test structure and surface PL of QD VECSEL excited at 532 nm with excitation densities of 300 and 30 W/cm², respectively. Inset: spatial intensity profile of the output beam recorded at 170 mW output power.

The devices are grown on Si-doped GaAs 2 in. substrates using metal-organic vapor phase epitaxy. After deoxidizing the wafers at 715 °C under arsine, a GaAs buffer layer, the DBR structure, and 130 nm GaAs of the subcavity are grown at 680 °C. Subsequently, the temperature is cycled between 500 °C for QD growth with tertiarybutylarsine and 595 °C for GaAs spacer growth with arsine. The final In_{0.48}Ga_{0.52}P window layer is grown using tertiarybutylphosphine at 595 °C. In order to tune the QD emission wavelength to 1210 nm, the In_{0.68}Ga_{0.32}As QDs are overgrown by a 3.9 nm thick In_{0.12}Ga_{0.88}As layer. Details of QD growth are given in Ref. 20. Optical reflectance spectra recorded by an optical spectrum analyzer are used to adjust the DBR stop band and the cavity length. To characterize QD and VECSEL emission room temperature PL measurements are performed on PL test structures and on complete VEC-SEL gain chips with excitation by a frequency-doubled Nd:YAG (yttrium aluminum garnet) laser at 532 nm. The PL test structures comprise two AlGaAs diffusion barriers enclosing the QD layers in the 300 nm GaAs matrix.

To investigate the stacking properties of the QDs, PL test structures with up to six QD layers are characterized (Fig. 1). Using recently developed, improved growth conditions for cap and spacer layers¹⁶ neither broadening nor shifting of the ground-state emission upon stacking is observed in the PL spectrum. This demonstrates the excellent overgrowth stability of the QD emission.

To assess VECSEL operation characteristics a 267 μ m thick natural diamond heat spreader is liquid capillary bonded onto the surface of a $2.5 \times 2.5 \text{ mm}^2$ gain-mirror piece. The bonded wafer is mounted on a water-cooled copper heat sink kept at 15 °C unless otherwise mentioned. Optical pumping is provided by a fiber-coupled diode laser delivering up to 50 W cw power at 790 nm, incident at 35° to the surface normal. Pump-spot size on the gain-chip surface and the size of the cavity mode are matched to a diameter of 180 μ m. The external V-shaped cavity is realized by a focusing mirror with a radius of curvature of 200 mm, a high reflectivity (99.8%) output-coupler mirror, and the gain chip itself. A very low pump power threshold density of $2-3 \text{ kW/cm}^2$ is achieved for all temperatures which is twice lower than recently reported for InGaAsN-QW based VECSELs.⁹ Threshold pump power is 0.48 W at 15 °C (Fig. 2). The Gaussian intensity profile of the laser beam (inset of



FIG. 2. (a) Slope efficiency of the VECSEL and (b) threshold pump power both measured with copper heat sink set to different temperatures.

Fig. 1) as recorded by a charge-coupled device camera at 170 mW output power indicates nearly diffraction-limited emission of the VECSEL. A maximum output power close to 300 mW is achieved for heat sink temperatures of up to 15 °C, being limited by the thermal rollover. With higher heat sink temperatures leading to thermal rollover comes up at lower temperatures (Fig. 1) but no degradation was observed for hours of operation at high pump power level. A temperature-independent differential efficiency of 2% is found. The low value results from the limited modal gain of the structure. Modeling suggests that a lower output coupling mirror reflectivity of 98% is sufficient for 30 grouped QD layers in order to achieve lasing. Emission spectra recorded at different heat sink temperatures (for a medium pump power level) shown in Fig. 3 demonstrate an excellent center wavelength stability of 0.06 nm/K. The value corresponds to the shift of the cavity resonance. In comparison, typical values of GaInNAs-QW based VECSELs show a shift of 0.3 nm/K.¹⁰ Emission-wavelength stability is proven by the almost constant center wavelengths in the spectra recorded at different output powers, cf. Figs. 4(a)-4(e). The dependence on pump power density is calculated to be 0.027 nm/(kW \times cm⁻²) independent of the heat sink temperature. This is in agreement with an almost constant peak wavelength of the PL emission shown in Fig. 4(f). A shift of only 2 nm and a broadening of 1 nm of full width at half maximum are found



FIG. 3. [(a)–(c)] Laser spectra of the VECSEL recorded at a medium pump power level of 30 kW/cm² with heat sink set to different temperatures.



FIG. 4. (Color online) [(a)-(e)] Laser spectra recorded at different output power levels with heat sink temperature set to 15 °C. (f) PL spectra recorded in a different VECSEL setup at different pump-power levels below lasing threshold.

as the pump power is increased from 30 to 190 kW/cm^2 . The shift corresponds to the resonance shift of the VECSEL.

In conclusion, we demonstrate temperature-independent ground-state cw lasing of a QD VECSEL at 1210 nm. Stable laser characteristics in terms of threshold, differential efficiency, and emission spectrum, being independent of the incident pump power and the heat sink temperature is achieved employing the broad and flat gain spectrum of a 21-fold InGaAs QD stack. The VECSEL shows stable operation without indications of degradation, a Gaussian beam profile, and close to 300 mW output power.

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